## 6-Pin DIP High Voltage Photodarlington Optocouplers

## H11G1M, H11G2M

## Description

The H11G1M and H11G2M are photodarlington-type optically coupled optocouplers. These devices have a gallium arsenide infrared emitting diode coupled with a silicon darlington connected phototransistor which has an integral base-emitter resistor to optimize elevated temperature characteristics.

## Features

- High BV ${ }_{\text {CEO }}$ :
- 100 V Minimum for H11G1M
- 80 V Minimum for H11G2M
- High Sensitivity to Low Input Current (Minimum $500 \%$ CTR at $\mathrm{I}_{\mathrm{F}}=1 \mathrm{~mA}$ )
- Low Leakage Current at Elevated Temperature
(Maximum $100 \mu \mathrm{~A}$ at $80^{\circ} \mathrm{C}$ )
- Safety and Regulatory Approvals:
- UL1577, 4,170 VAC RMS for 1 Minute
- DIN-EN/IEC60747-5-5, 850 V Peak Working Insulation Voltage


## Application

- CMOS Logic Interface
- Telephone Ring Detector
- Low Input TTL Interface
- Power Supply Isolation
- Replace Pulse Transformer

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## MARKING DIAGRAM



| H11G1 $=$ | Specific Device Code |
| :--- | :--- |
| V | $=$ DIN EN/IEC60747-5-5 Option (only |
|  | appears on component ordered with |
| this option) |  |
| X | $=$ One-Digit Year Code |
| YY | $=$ Digit Work Week |
| Q | $=$ Assembly Package Code |

SCHEMATIC


## ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

## SAFETY AND INSULATION RATINGS

(As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.)

| Parameter |  | Characteristics |
| :---: | :---: | :---: |
| Installation Classifications per DIN VDE 0110/1.89 Table 1, For Rated Mains Voltage | <150 V ${ }_{\text {RMS }}$ | I-IV |
|  | $<300 \mathrm{~V}_{\text {RMS }}$ | I-IV |
| Climatic Classification |  | 55/100/21 |
| Pollution Degree (DIN VDE 0110/1.89) |  | 2 |
| Comparative Tracking Index |  | 175 |


| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| $V_{P R}$ | Input-to-Output Test Voltage, Method A, $\mathrm{V}_{\text {IORM }} \times 1.6=\mathrm{V}_{\mathrm{PR}}$, Type and Sample Test with $\mathrm{t}_{\mathrm{m}}=10 \mathrm{~s}$, Partial Discharge $<5 \mathrm{pC}$ | 1360 | $V_{\text {peak }}$ |
|  | Input-to-Output Test Voltage, Method B, $\mathrm{V}_{\mathrm{IORM}} \times 1.875=\mathrm{V}_{\mathrm{PR}}$, $100 \%$ Production Test with $\mathrm{t}_{\mathrm{m}}=1 \mathrm{~s}$, Partial Discharge $<5 \mathrm{pC}$ | 1594 | $\mathrm{V}_{\text {peak }}$ |
| $\mathrm{V}_{\text {IORM }}$ | Maximum Working Insulation Voltage | 850 | $\mathrm{V}_{\text {peak }}$ |
| $\mathrm{V}_{\text {IOTM }}$ | Highest Allowable Over-Voltage | 6000 | $V_{\text {peak }}$ |
|  | External Creepage | $\geq 7$ | mm |
|  | External Clearance | $\geq 7$ | mm |
|  | External Clearance (for Option TV, 0.4" Lead Spacing) | $\geq 10$ | mm |
| DTI | Distance Through Insulation (Insulation Thickness) | $\geq 0.5$ | mm |
| $\mathrm{T}_{\mathrm{S}}$ | Case Temperature (Note 1) | 175 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{I}_{\text {S,INPUT }}$ | Input Current (Note 1) | 350 | mA |
| $\mathrm{P}_{\text {S, OUTPUT }}$ | Output Power (Note 1) | 800 | mW |
| $\mathrm{R}_{\mathrm{IO}}$ | Insulation Resistance at $\mathrm{T}_{\mathrm{S}}, \mathrm{V}_{1 \mathrm{O}}=500 \mathrm{~V}$ (Note 1) | $>10^{9}$ | $\Omega$ |

1. Safety limit values - maximum values allowed in the event of a failure.

## ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Max | Unit |
| :---: | :---: | :---: | :---: |

TOTAL DEVICE

| $\mathrm{T}_{\text {STG }}$ | Storage Temperature | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |
| :---: | :--- | :---: | :---: |
| $\mathrm{T}_{\text {OPR }}$ | Operating Temperature | -40 to +100 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{J}}$ | Junction Temperature | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {SOL }}$ | Lead Solder Temperature | 260 for 10 seconds | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\mathrm{D}}$ | Total Device Power Dissipation $@ \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 290 | mW |
|  | Derate Above $25^{\circ} \mathrm{C}$ | 3.5 | $\mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |

## EMITTER

| $\mathrm{I}_{\mathrm{F}}$ | DC / Average Forward Input Current | 60 | mA |
| :---: | :--- | :---: | :---: |
| $\mathrm{~V}_{\mathrm{R}}$ | Reverse Input Voltage | 6.0 | V |
| $\mathrm{I}_{\mathrm{F}}(\mathrm{pk})$ | Forward Current - Peak $(1 \mu \mathrm{~s}$ pulse, 300 pps$)$ | 3.0 | A |
| $\mathrm{P}_{\mathrm{D}}$ | LED Power Dissipation @ $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 90 | mW |
|  | Derate Above $25^{\circ} \mathrm{C}$ | 1.8 | $\mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |

## DETECTOR

| $\mathrm{V}_{\text {CEO }}$ | Collector Emitter Voltage | H11G1M | 100 | V |
| :---: | :--- | :---: | :---: | :---: |
|  |  | H11G2M | 80 | V |
| $\mathrm{P}_{\mathrm{D}}$ | Photodetector Power Dissipation $@ \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 200 | mW |  |
|  | Derate Above $25^{\circ} \mathrm{C}$ | 2.67 | $\mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |  |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS - INDIVIDUAL COMPONENT CHARACTERISTICS
( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| EMITTER |  |  |  |  |  |  |
| $V_{F}$ | Forward Voltage | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ | - | 1.3 | 1.5 | V |
| $\Delta \mathrm{V}_{\mathrm{F}} / \Delta \mathrm{T}_{\mathrm{A}}$ | Forward Voltage Temperature Coefficient |  | - | -1.8 | - | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{BV}_{\mathrm{R}}$ | Reverse Breakdown Voltage | $\mathrm{I}_{\mathrm{R}}=10 \mu \mathrm{~A}$ | 3.0 | 25 | - | V |
| CJ | Junction Capacitance | $\mathrm{V}_{\mathrm{F}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 50 | - | pF |
|  |  | $\mathrm{V}_{\mathrm{F}}=1 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 65 | - | pF |
| $\mathrm{I}_{\mathrm{R}}$ | Reverse Leakage Current | $\mathrm{V}_{\mathrm{R}}=3.0 \mathrm{~V}$ | - | 0.001 | 10 | $\mu \mathrm{A}$ |

## DETECTOR

| $\mathrm{BV}_{\text {CEO }}$ | Breakdown Voltage Collector to Emitter | H11G1M | $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{~mA}, \mathrm{I}_{\mathrm{F}}=0$ | 100 | - | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | H11G2M |  | 80 | - | - | V |
| $\mathrm{BV}_{\mathrm{CBO}}$ | Collector to Base | H11G1M | $\mathrm{I}_{\mathrm{C}}=100 \mu \mathrm{~A}$ | 100 | - | - | V |
|  |  | H11G2M |  | 80 | - | - | V |
| $\mathrm{BV}_{\text {Ebo }}$ | Emitter Base |  |  | 7 | 10 | - | V |
| $I_{\text {cee }}$ | Leakage Current Collector to Emitter | H11G1M | $\mathrm{V}_{\mathrm{CE}}=80 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=0$ | - | - | 100 | nA |
|  |  | H11G2M | $\mathrm{V}_{\text {CE }}=60 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=0$ | - | - | 100 | nA |
|  |  | H11G1M | $\mathrm{V}_{\text {CE }}=80 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=0, \mathrm{~T}_{\mathrm{A}}=80^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |
|  |  | H11G2M | $\mathrm{V}_{\text {CE }}=60 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=0, \mathrm{~T}_{\mathrm{A}}=80^{\circ} \mathrm{C}$ | - | - | 100 | $\mu \mathrm{A}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS - TRANSFER CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| EMITTER |  |  |  |  |  |  |
| CTR | Current Transfer Ratio, Collector to Emitter | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=1 \mathrm{~V}$ | $\begin{gathered} 100 \\ (1000) \end{gathered}$ | - | - | mA (\%) |
|  |  | $\mathrm{I}_{\mathrm{F}}=1 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=5 \mathrm{~V}$ | 5 (500) | - | - | mA (\%) |
| $\mathrm{V}_{\text {CE (SAT) }}$ | Saturation Voltage | $\mathrm{I}_{\mathrm{F}}=16 \mathrm{~mA}, \mathrm{I}_{\mathrm{C}}=50 \mathrm{~mA}$, | - | 0.85 | 1.0 | V |
|  |  | $\mathrm{I}_{\mathrm{F}}=1 \mathrm{~mA}, \mathrm{I}_{\mathrm{C}}=1 \mathrm{~mA}$, | - | 0.75 | 1.0 | V |

## SWITCHING TIMES

| $\mathrm{t}_{\mathrm{ON}}$ | Turn on Time | $\begin{aligned} & R_{L}=100 \Omega, \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=5 \mathrm{~V}, \\ & \mathrm{f} \leq 30 \mathrm{~Hz} \text {, Pulse Width } \leq 300 \mu \mathrm{~s} \end{aligned}$ | - | 5 | - | $\mu \mathrm{S}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| toff | Turn off Time |  | - | 100 | - | $\mu \mathrm{s}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS - ISOLATION CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {ISO }}$ | Input-Output Isolation Voltage | $\mathrm{t}=1$ Minute | 4170 | - | - | $\mathrm{VAC}_{\mathrm{RMS}}$ |
| $\mathrm{C}_{\text {ISO }}$ | Isolation Capacitance | $\mathrm{V}_{\mathrm{I}-\mathrm{O}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 0.2 | - | pF |
| $\mathrm{R}_{\text {ISO }}$ | Isolation Resistance | $\mathrm{V}_{\mathrm{I}-\mathrm{O}}= \pm 500 \mathrm{VDC}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $10^{11}$ | - | - | $\Omega$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## TYPICAL PERFORMANCE CURVES



Figure 1. Output Current vs. Input Current

$\mathrm{V}_{\mathrm{CE}}$, COLLECTOR-EMITTER VOLTAGE (V)
Figure 3. Output Current vs. Collector-Emitter Voltage


Figure 2. Normalized Output Current vs. Temperature


Figure 4. Collector-Emitter Dark Current vs. Ambient Temperature


Figure 5. Input Current vs. Total Switching Speed (Typical Values)

## H11G1M, H11G2M

## REFLOW PROFILE



| Profile Feature | Pb-Free Assembly Profile |
| :---: | :---: |
| Temperature Min. (Tsmin) | $150^{\circ} \mathrm{C}$ |
| Temperature Max. (Tsmax) | $200^{\circ} \mathrm{C}$ |
| Time ( $\mathrm{t}_{\mathrm{S}}$ ) from (Tsmin to Tsmax) | 60-120 seconds |
| Ramp-up Rate ( $\mathrm{t}_{\mathrm{L}}$ to $\mathrm{t}_{\mathrm{P}}$ ) | $3^{\circ} \mathrm{C} /$ second max. |
| Liquidous Temperature ( $\mathrm{T}_{\mathrm{L}}$ ) | $217^{\circ} \mathrm{C}$ |
| Time ( $\mathrm{t}_{\mathrm{L}}$ ) Maintained Above ( $\mathrm{T}_{\mathrm{L}}$ ) | 60-150 seconds |
| Peak Body Package Temperature | $260^{\circ} \mathrm{C}+0^{\circ} \mathrm{C} /-5^{\circ} \mathrm{C}$ |
| Time ( $t_{p}$ ) within $5^{\circ} \mathrm{C}$ of $260^{\circ} \mathrm{C}$ | 30 seconds |
| Ramp-down Rate ( $\mathrm{T}_{\mathrm{P}}$ to $\mathrm{T}_{\mathrm{L}}$ ) | $6^{\circ} \mathrm{C} /$ second max. |
| Time $25^{\circ} \mathrm{C}$ to Peak Temperature | 8 minutes max. |

Figure 6. Reflow Profile

## H11G1M, H11G2M

ORDERING INFORMATION

| Part Number | Package | Shipping $^{\dagger}$ |
| :--- | :--- | :---: |
| H11G1M | DIP 6-Pin | 50 Units / Tube |
| H11G1SM | SMT 6-Pin (Lead Bend) | 50 Units / Tube |
| H11G1SR2M | SMT 6-Pin (Lead Bend) | 1000 / Tape \& Reel |
| H11G1VM | DIP 6-Pin, DIN EN/IEC60747-5-5 Option | 50 Units / Tube |
| H11G1SVM | SMT 6-Pin (Lead Bend), <br> DIN EN/IEC60747-5-5 Option | 50 Units / Tube |
| H11G1SR2VM | SMT 6-Pin (Lead Bend), <br> DIN EN/IEC60747-5-5 Option | 1000 / Tape \& Reel |
| H11G1TVM | DIP 6-Pin, 0.4" Lead Spacing, <br> DIN EN/IEC60747-5-5 Option | 50 Units / Tube |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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